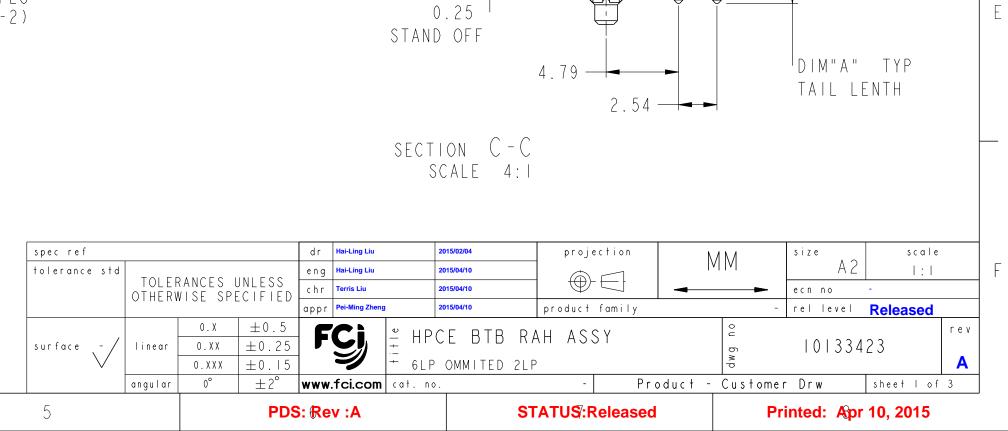
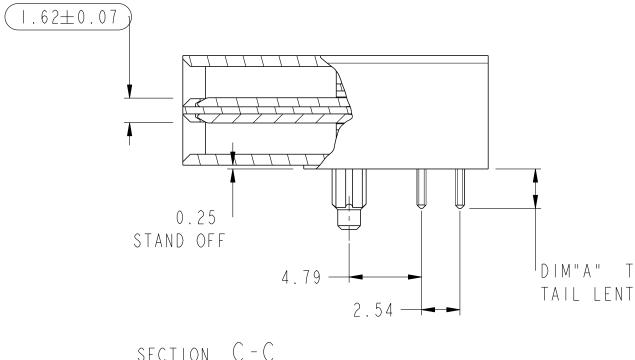
	2		3	4		
A			23.64		-	
В		20.20			HOUSI SEE N	NG OTE 7
С					NOTE 5	
D	2 x 2	. 25 —		-OMMITED P9 PIO		00 LD-DOWN EE TABL
Copyright FCI.						

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	2	3	4	







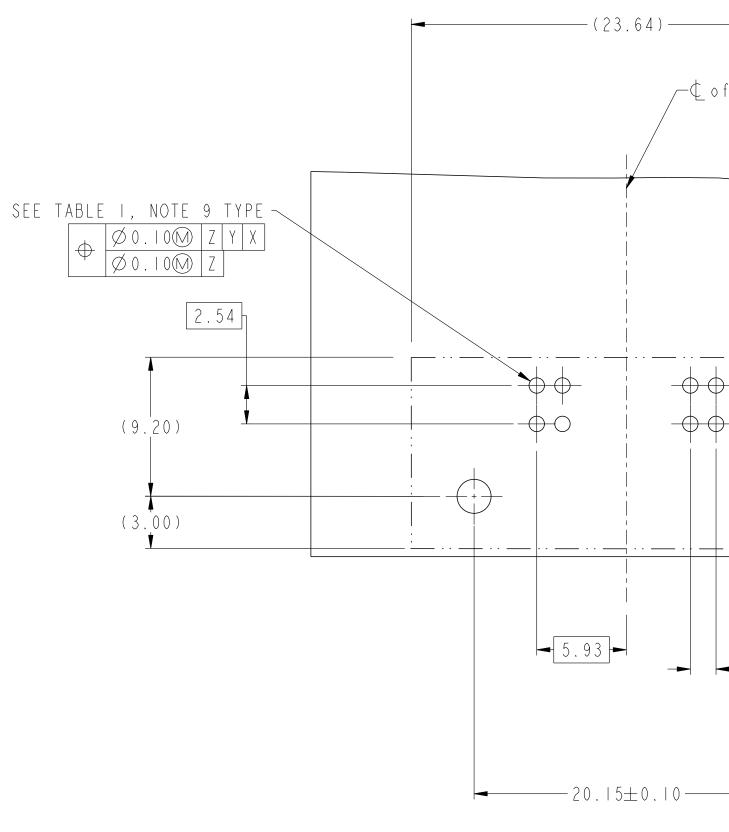
А

В

С

D

		2	3	4	5	6	7	8
	CONTACT TYPE	TOP LAYER DESCRIPTION		TABLE I (HPCE / SOLDER PLATED THROUGH-HOLE REQUI	REMENTS			
A	POWER	TIN-LEAD IMMERSION TIN COPPER (SEE NOTE 8)	I.IO-I.I6 (I.I5 DRILL) O	COPPER THICKNESSTIN-LE, THICKNE.025 - 0.0500.005 - 0.025 - 0.050025 - 0.050	SS THICKNESS HOLE .015 0.94 0.9 - 1.5um 0.94	NISHED DIAMETER 4 - I.IO 4 - I.IO 4 - I.IO		A
	SIGNAL	TIN-LEAD IMMERSION TIN COPPER (SEE NOTE 8)	0.93-0.99 (0.98 DRILL) 0 0.93-0.99 (0.98 DRILL) 0	.025 - 0.050 0.005 - 0 .025 - 0.050 .025 - 0.050	.015 0.77 0.9 - 1.5um 0.77	7 - 0.93 7 - 0.93 7 - 0.93		
В				(23.6	4) ————			В
					¢ ofDTM X			- Z
С		SEE TAE	BLE I, NOTE 9 TYPE			-CONNECTOR OUTLINE		С
			(9.20)			4.79 Y		
D			(3.00)			PLATED HOLE (2x) TE NOTE IO FOR DIAMETER)		
E				 − <u>5.93</u> −	I.70 PITCH			E
				TOP SI RECOMMENDE	JRFACE D PCB LAYOUT			
Copyright FCI.						d r Hai-Ling Liu 2015/02/04 e n g Hai-Ling Liu 2015/04/10	projection	MM size scale A2 I:I F
	Pro/E File - REV C - 2009-06-09					chr Terris Liu 2015/04/10 appr Pei-Ming Zheng 2015/04/10	product family RAH ASSY 2LP	ecn no rel level Released rev rev rev Released rev A Customer Drw sheet 2 of 3 Printed: Por 10, 2015



Pro/E File - REV C - 2009-06-09				
	2	ζ	Δ	
I	L	\checkmark	7	

			2		3		4
			PART NUMBER (TABLE 2)			
	PART NUMBER	TAIL TYPE	OPTIONAL PLASTIC PEG	DIM "A" TAIL L		RECOMMENDED BOAR THICKNESS	R D
A	10132353-001LF		YES	2.60±0.25	0 25	1 57	
	10132353-002LF	SOLDER	NO		Ι.57		
	10132353-003LF	TAIL	YES	2 251	0.25	2 26	
	10132353-004LF		NO	- 3.25±0	ΞΨ. ΖΟ	2.36	

В

С

D

IJ

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F

NOTES:

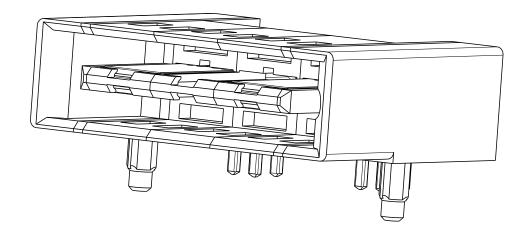
I. CONNECTOR MATERIALS:

HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, BLACK UL 94V-0 COMPLIANT CONTACTS: HIGH PERFORMANCE COPPER ALLOY.

- CONTACT FINISH REF. GS-12-1031 SECTION TBD 2.
- PRODUCT SPECIFICATION: GS-12-1125 3.
- APPLICATION SPECIFICATION: GS-20-0388 4.
- PRODUCT MARKING (FCI PART NUMBER & DATE CODE) ON HOUSING IN AREA SHOWN. $(\bar{5}).$
- PACKAGING MEETS FCI SPECIFICATION GS-14-2272. 6.
- HOUSING COMPONENT WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 60 SECONDS IN A CONVECTION, INFRA-RED, OR VAPOR PHASE REFLOW OVEN. (7).
- COPPER PLATING THICKNESS IN CENTER OF VIA-HOLE CAN BE NO MORE THAN 0.003 LESS THAN OTHER AREAS. (8).
- (9). ALL HOLE SIZES ARE FINISHED HOLE SIZES.
- (10). MOUNTING HOLES ARE UNPLATED $otin 2.20 \pm 0.05$ For solder tails

Pro/E File - REV C - 2009-06-09	2	3	4	

_			
5	6	7	8
-			



DS: Rev :A			ATUS:R	eleased		Pri	nted: Apr	10, 2015	
www.	. fci.com cat. no		-	Pro	duct -	Customer	Drw	sheet 3 of	3
F	FS HPCE BTB			SΥ		dwg no	01334	23	rev A
appr	Pei-Ming Zheng	2015/04/10	product	family		-	rel level	Released	
chr	Terris Liu	2015/04/10			-		ecn no	-	
eng	Hai-Ling Liu	2015/04/10			١v	v	A 2	1:1	
dr	Hai-Ling Liu	2015/02/04	proje	ction	N	1M	size	scale	